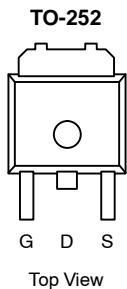


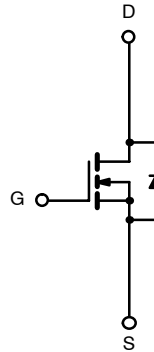


N-Channel 22-V (D-S) 175°C MOSFET

PRODUCT SUMMARY		
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A) ^d
24 ^c	0.0095 @ V _{GS} = 10 V	49
	0.017 @ V _{GS} = 4.5 V	36



Drain Connected to Tab



N-Channel MOSFET

FEATURES

- TrenchFET® Power MOSFET
- 175°C Junction Temperature
- PWM Optimized for High Efficiency

APPLICATIONS

- High-Side Synchronous Buck DC/DC Conversion
 - Desktop
 - Server

Ordering Information: SUD50N024-09P
SUD50N024-09P—E3 (Lead Free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C UNLESS OTHERWISE NOTED)				
Parameter		Symbol	Limit	Unit
Drain-Source Pulse Voltage		V _{DS(pulse)}	24 ^c	V
Drain-Source Voltage		V _{DS}	22	
Gate-Source Voltage		V _{GS}	±20	
Continuous Drain Current ^a	T _C = 25°C	I _D	49 ^d	A
	T _C = 100°C		34 ^d	
Pulsed Drain Current		I _{DM}	100	
Continuous Source Current (Diode Conduction) ^a		I _S	4.3	
Avalanche Current, Single Pulse	L = 0.1 mH	I _{AS}	29	
Avalanche Energy, Single Pulse		E _{AS}	42	mJ
Maximum Power Dissipation	T _A = 25°C	P _D	6.5 ^a	W
	T _C = 25°C		39.5	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	R _{thJA}	19	23	°C/W
	Steady State		40	50	
Maximum Junction-to-Case		R _{thJC}	3.1	3.8	

Notes

- Surface Mounted on FR4 Board, t ≤ 10 sec.
- Limited by package
- Pulse condition: T_A = 105°C, 50 ns, 300 kHz operation
- Calculation based on maximum allowable Junction Temperature. Package limitation current is 25 A.

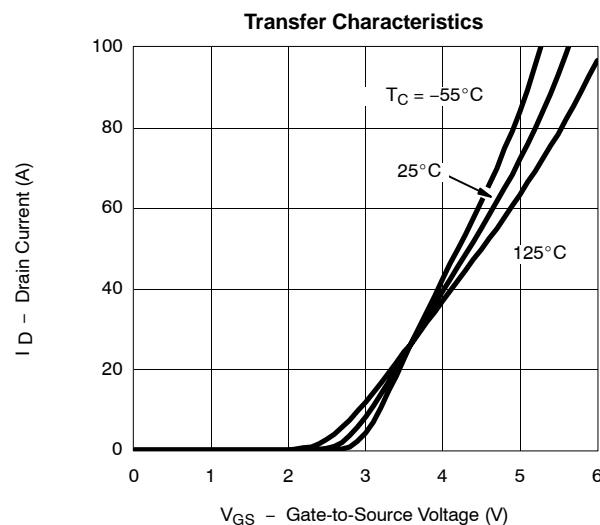
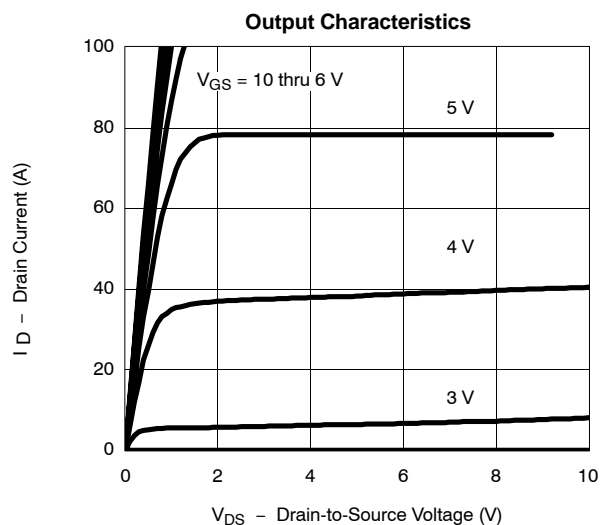


SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ ^a	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA	22			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.8		3.0	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V			1	μA
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 125°C			50	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	50			A
Drain-Source On-State Resistance ^b	r _{DS(on)}	V _{GS} = 10 V, I _D = 20 A		0.008	0.0095	Ω
		V _{GS} = 10 V, I _D = 20 A, T _J = 125°C			0.014	
		V _{GS} = 4.5 V, I _D = 20 A		0.0135	0.017	
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 20 A	15			S
Dynamic^a						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 10 V, f = 1 MHz		1300		pF
Output Capacitance	C _{oss}			470		
Reverse Transfer Capacitance	C _{rss}			275		
Gate Resistance	R _g		1.6	4.0	6	Ω
Total Gate Charge ^c	Q _g	V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 50 A		10.5	16	nC
Gate-Source Charge ^c	Q _{gs}			4.2		
Gate-Drain Charge ^c	Q _{gd}			4.0		
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 10 V, R _L = 0.2 Ω I _D ≅ 50 A, V _{GEN} = 10 V, R _g = 2.5 Ω		8	12	ns
Rise Time ^c	t _r			10	15	
Turn-Off Delay Time ^c	t _{d(off)}			25	40	
Fall Time ^c	t _f			12	20	
Source-Drain Diode Ratings and Characteristic (T_C = 25°C)						
Pulsed Current	I _{SM}				100	A
Diode Forward Voltage ^b	V _{SD}	I _F = 50 A, V _{GS} = 0 V		1.2	1.5	V
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 50 A, di/dt = 100 A/μs		35	70	ns

Notes

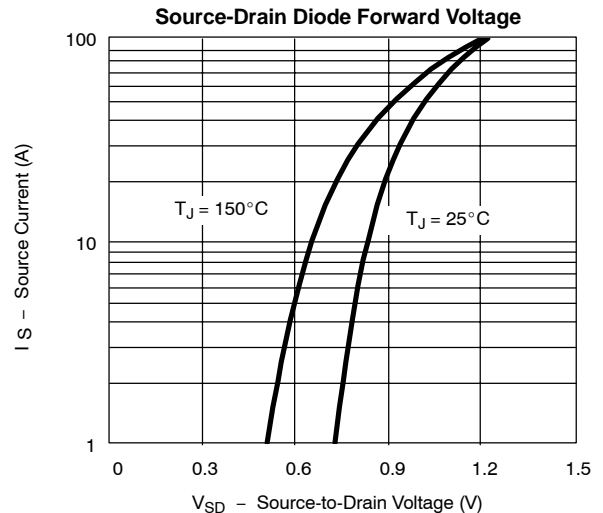
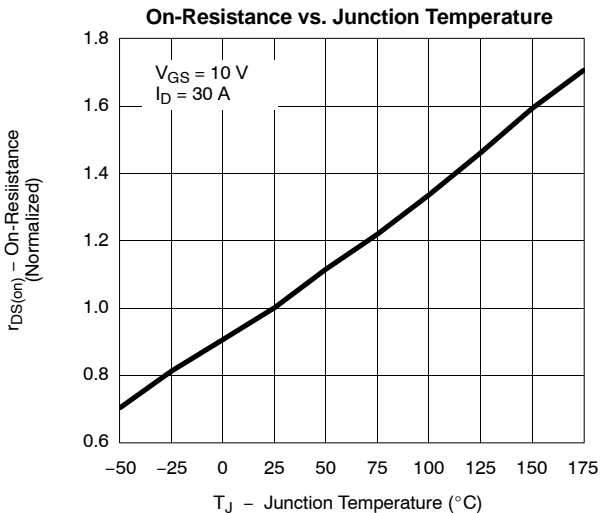
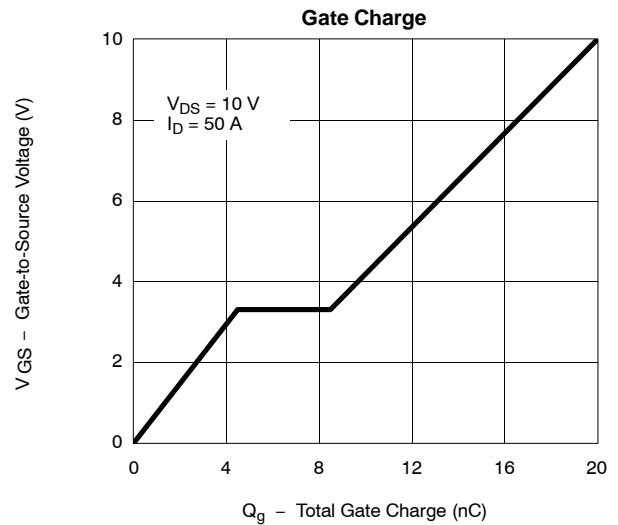
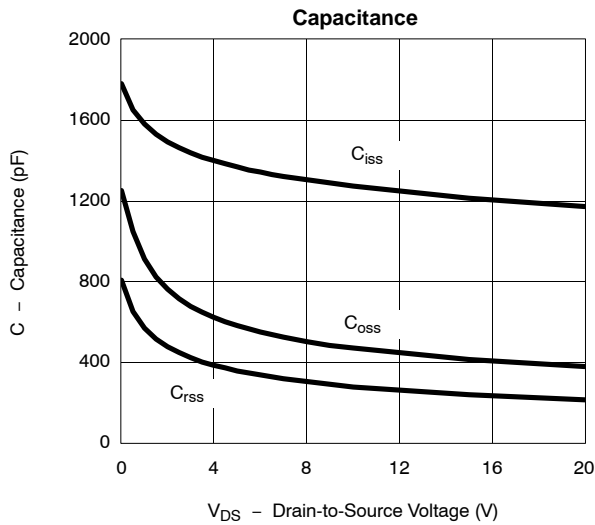
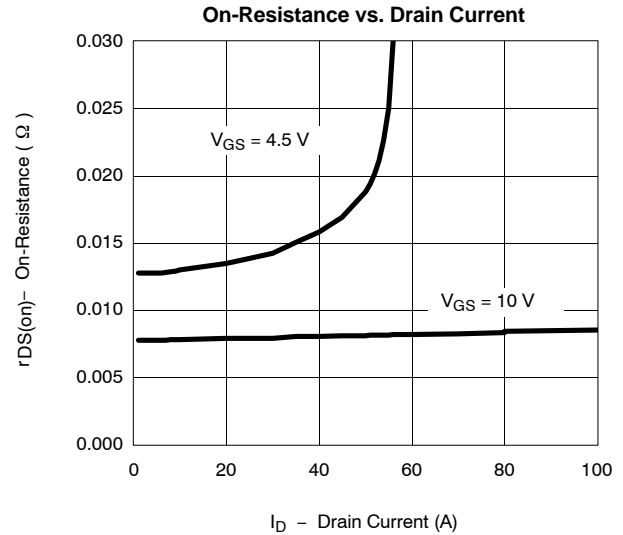
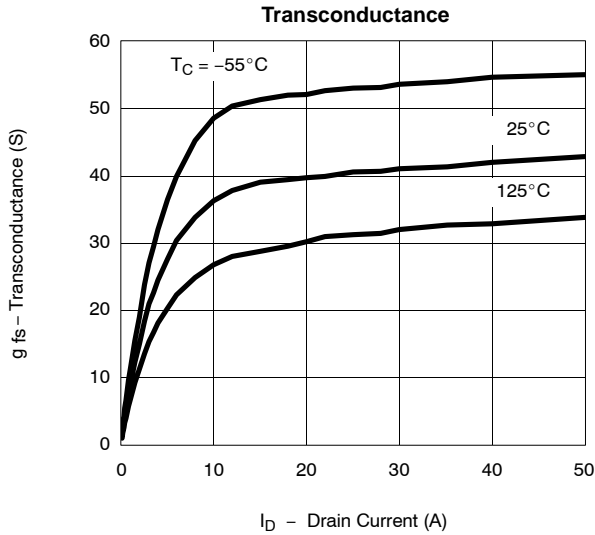
- Guaranteed by design, not subject to production testing.
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- Independent of operating temperature.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



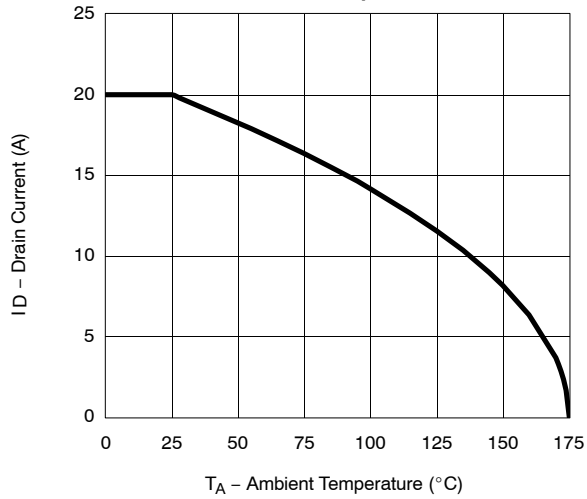


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

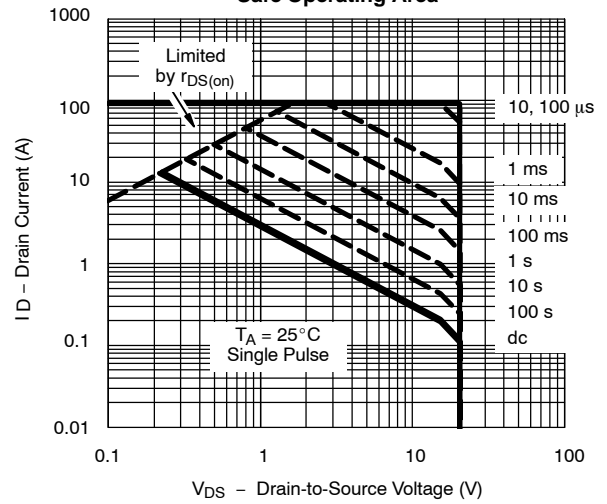


THERMAL RATINGS

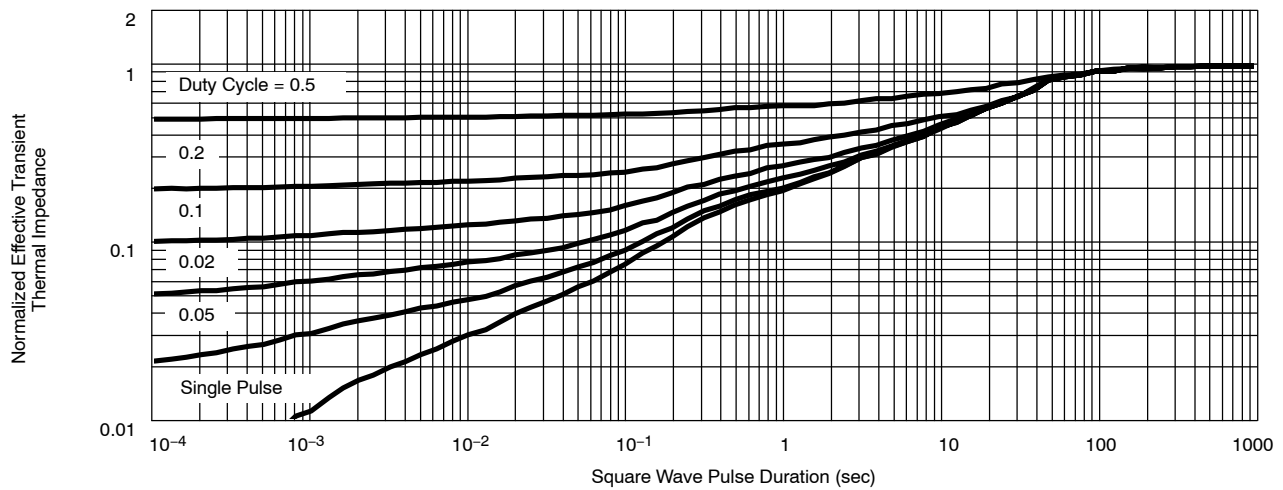
Maximum Drain Current vs. Ambient Temperature



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient





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